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LED Light Bars

HLCP-A100/-B100/-C100/D100/-E100/-F100/-G100/-H100

HLMP-2300/-2350/-2400/-2450/-2500/-2550

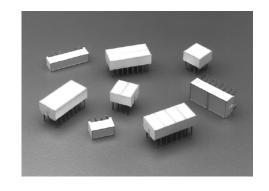
HLMP-2600/-2620/-2635/-2655/-2670/-2685

HLMP-2700/-2720/-2735/-2755/-2770/-2785

HLMP-2800/-2820/-2835/-2855/-2870/-2885

HLMP-2950/-2965

Data Sheet



Description

The HLCP-X100 and HLMP-2XXX series light bars are rectangular light sources designed for a variety of applications where a large bright source of light is required. These light bars are configured in single-in-line and dual-in-line packages that contain either single or segmented light emitting areas. The Al-GaAs Red HLCP-X100 series LEDs use double hetero-junction AlGaAs on a GaAs substrate. The HER HLMP-2300/2600 and Yellow HLMP-2400/2700 series LEDs have their p-n junctions diffused into a GaAsP epitaxial layer on a GaP substrate. The Green HLMP-2500/2800 series LEDs use a liquid phase GaP epitaxial layer on a GaP substrate. The bicolor HLMP-2900 series use a combination of HER/Yellow or HER/ Green LEDs.

Features

- Large bright, uniform light emitting areas
- Choice of colors
- Categorized for light output
- Yellow and Green categorized for dominant wavelength
- Excellent ON-OFF contrast
- X-Y stackable
- Flush mountable
- Can be used with panel and legend mounts
- Light emitting surface suitable for legend attachment per Application Note 1012
- HLCP-X100 Series designed for low current operation
- Bicolor devices available

Applications

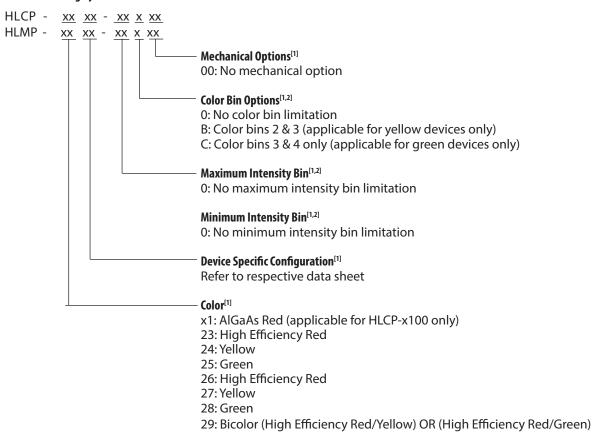
- Business machine message annunciators
- Telecommunications indicators
- Front panel process status indicators
- PC board identifiers
- Bar graphs



Selection Guide

ight Bar Part Number			r Part Number				
HLCP-	HLCP- HLMP-		Size of Light	Number of Light			
AlGaAs	HER	Yellow	Green	Emitting Areas	Emitting Areas	Package Outline	
A100	2300	2400	2500	8.89 mm x 3.81 mm (.350 in. x .150 in.)	1	Α 🗔	
B100	2350	2450	2550	19.05 mm x 3.81 mm (.750 in. x .150 in.)	1	В	
D100	2600	2700	2800	8.89 mm x 3.81 mm (.350 in. x .150 in.)	2	р 🔲	
E100	2620	2720	2820	8.89 mm x 3.81 mm (.350 in. x .150 in.)	4	Е ППП	
F100	2635	2735	2835	3.81 mm x 19.05 mm (.150 in. x .750 in.)	2	F ===	
C100	2655	2755	2855	8.89 mm x 8.89 mm (.350 in. x .350 in.)	1	С	
G100	2670	2770	2870	8.89 mm x 8.89 mm (.350 in. x .350 in.)	2	G	
	2685	2785	2885	8.89 mm x 19.05 mm (.350 in. x .750 in.)	1	н	
H100	2950	2950		8.89 mm x 8.89 mm (.350 in. x .350 in.)	Bicolor	Ι 🔲	
	2965		2965	8.89 mm x 8.89 mm (.350 in. x .350 in.)	Bicolor	I 🗌	

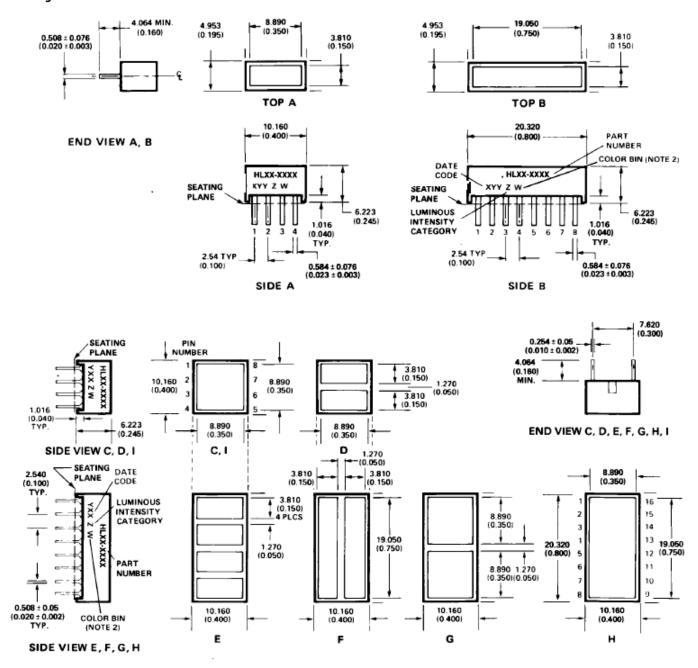
Part Numbering System



Notes:

- 1. For codes not listed in the figure above, please refer to the respective data sheet or contact your nearest Avago representative for details.
- 2. Bin options refer to shippable bins for a part-number. Color and Intensity Bins are typically restricted to 1 bin per tube (exceptions may apply). Please refer to respective data sheet for specific bin limit information.

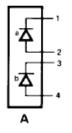
Package Dimensions

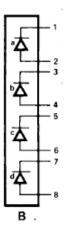


NOTES:

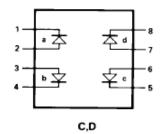
- 1. DIMENSIONS IN MILLIMETRES (INCHES). TOLERANCES ± 0.25 mm (± 0.010 IN.) UNLESS OTHERWISE INDICATED.
- 2. FOR YELLOW AND GREEN DEVICES ONLY.

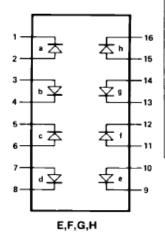
Internal Circuit Diagrams



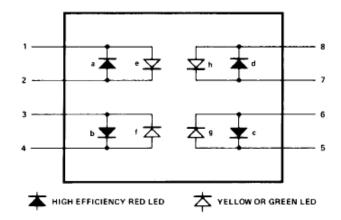


PIN FUNCTION					
PIN	A -2300/-2400 -2500/A100	B -2350/-2450 -2550/B100			
1	CATHODE a	CATHODE a			
2	ANODE a	ANODE a			
3	CATHODE b	CATHODE b			
4	ANODE b	ANODE b			
5		CATHODE c			
6		ANODE c			
7		CATHODE d			
8		ANODE d			





PIN	PIN FU	NCTION
	C, D	E, F, G, H
1	CATHODE a	CATHODE a
2	ANODE a	ANODE a
3	ANODE b	ANODE b
4	CATHODE b	CATHODE b
5	CATHODE c	CATHODE c
6	ANODE c	ANODE c
7	ANODE d	ANODE d
8	CATHODE d	CATHODE d
9		CATHODE e
10		ANODE e
11		ANODE f
12		CATHODE f
13		CATHODE g
14		ANODE g
15		ANODE h
16		CATHODE h



	PIN FUNCTION						
PIN	HER	YELLOW/ GREEN					
1	CATHODE a	ANODE e					
2	ANODE a	CATHODE e					
3	ANODE b	CATHODE f					
4	CATHODE b	ANODE f					
5	CATHODE c	ANODE 9					
6	ANODE c	CATHODE g					
7	ANODE d	CATHODE h					
8	CATHODE d	ANODE h					

Absolute Maximum Ratings

Parameter	AlGaAs Red HLCP-X100 Series	HER HLMP-2300/ 2600/29XX Series	Yellow HLMP-2400/ 2700/2950 Series	Green HLMP-2500/ 2800/2965 Series		
Average Power Dissipated per LED Chip	37 mW ^[1]	135 mW ^[2]	85 mW ^[3]	135 mW ^[2]		
Peak Forward Current per LED Chip	45 mA ^[4]	90 mA ^[5]	60 mA ^[5]	90 mA ^[5]		
Average Forward Current per LED Chip	15 mA	25 mA	20 mA	25 mA		
DC Forward Current per LED Chip	15 mA ^[1]	30 mA ^[2]	25 mA ^[3]	30 mA ^[2]		
Reverse Voltage* per LED Chip	5 V		6 V ^[6]			
Operating Temperature Range	-20°C to +100°C ^[7]	-40°C to +85°C		-20°C to +85°C		
Storage Temperature Range	-40°C to +85°C					
Wave Soldering Temperature 1.6 mm (1/16 inch) below Body		250°C for 3	seconds			

^{*} Reverse Voltage is for LED testing purpose and not recommended to be used as application condition.

Notes:

- 1. Derate above 87°C at 1.7 mW/°C per LED chip. For DC operation, derate above 91°C at 0.8 mA/°C.
- 2. Derate above 25°C at 1.8 mW/°C per LED chip. For DC operation, derate above 50°C at 0.5 mA/°C.
- 3. Derate above 50°C at 1.8 mW/°C per LED chip. For DC operation, derate above 60°C at 0.5 mA/°C.
- 4. See Figure 1 to establish pulsed operation. Maximum pulse width is 1.5 mS.
- 5. See Figure 6 to establish pulsed operation. Maximum pulse width is 2 mS.
- 6. Does not apply to bicolor parts.
 7. For operation below -20°C, contact your local Avago sales representative.

Electrical/Optical Characteristics at $T_{A} = 25^{\circ}C$ **AIGaAs Red HLCP-X100 Series**

Parameter	HLCP-	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Luminous Intensity	A100/D100/E100	I _v	3	7.5		mcd	$I_F = 3 \text{ mA}$
per Lighting Emitting Area ^[1]	B100/C100/F100/G100	_	6	15		mcd	
Alea	H100	_	12	30		mcd	
Peak Wavelength		λ_{PEAK}		645		nm	
Dominant Wavelength ^[2]		λ_{d}		637		nm	
Forward Voltage per LED		V _F		1.8	2.2	V	$I_F = 20 \text{ mA}$
Reverse Breakdown Voltage per LED		$V_{_{\mathrm{R}}}$	5	15		V	$I_R = 100 \mu\text{A}$
Thermal Resistance LED	Junction-to-Pin	$R\theta_{J-PIN}$		250		°C/W/ LED	

High Efficiency Red HLMP-2300/2600/2900 Series

Parameter	HLMP-	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Luminous Intensity per	2300/2600/2620	I _v	6	23		mcd	I _F = 20 mA
Lighting Emitting Area ^[1]	2350/2635/2655/2670/2950[3]		13	45		mcd	
	2965 ^[4]		19	45		mcd	
	2685		22	80		mcd	
Peak Wavelength		λ_{PEAK}		635		nm	
Dominant Wavelength ^[2]		λ_{d}		626		nm	
Forward Voltage per LED		V _F		2.0	2.6	V	$I_F = 20 \text{ mA}$
Reverse Breakdown Voltage per LED ^[5]		$V_{_{\rm R}}$	6	15		V	$I_R = 100 \mu A$
Thermal Resistance LED Junction-to-Pin		$R\theta_{J-PIN}$		150		°C/W/ LED	

Yellow HLMP-2400/2700/2950 Series

Parameter	HLMP-	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Luminous Intensity per	2400/2700/2720	I _v	6	20		mcd	$I_F = 20 \text{ mA}$
Lighting Emitting Area ^[1]	2450/2735/2755/2770/2950 ^[3]		13	38		mcd	
	2785		26	70		mcd	
Peak Wavelength		λ_{PEAK}		583		nm	
Dominant Wavelength ^[2]		λ_{d}		585		nm	
Forward Voltage per LED		V _F		2.1	2.6	V	$I_F = 20 \text{ mA}$
Reverse Breakdown Voltage per LED ^[5]		V _R	6	15		V	$I_{R} = 100 \mu A$
Thermal Resistance LED Junction-to-Pin		$R\theta_{J-PIN}$		150		°C/W/ LED	

High Performance Green HLMP-2500/2800/2965 Series

Parameter	HLMP-	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Luminous Intensity per	2500/2800/2820	I _v	5	25		mcd	$I_F = 20 \text{ mA}$
Lighting Emitting Area ^[1]	2550/2835/2855/2870		11	50		mcd	
	2965[4]		25	50		mcd	
	2885		22	100		mcd	
Peak Wavelength		λ_{PEAK}		565		nm	
Dominant Wavelength ^[2]		λ_{d}		572		nm	
Forward Voltage per LED		V _F		2.2	2.6	V	$I_F = 20 \text{ mA}$
Reverse Breakdown Voltage per LED ^[5]		V_R	6	15		V	$I_R = 100 \mu A$
Thermal Resistance LED Ju	unction-to-Pin	$R\theta_{J-PIN}$		150		°C/W/ LED	

Notes:

- 1. These devices are categorized for luminous intensity. The intensity category is designated by a letter code on the side of the package.
- 2. The dominant wavelength, $\lambda_{d'}$ is derived from the CIE chromaticity diagram and is the single wavelength which defines the color of the device. Yellow and Green devices are categorized for dominant wavelength with the color bin designated by a number code on the side of the package.
- 3. This is an HER/Yellow bicolor light bar. HER electrical/optical characteristics are shown in the HER table. Yellow electrical/optical characteristics are shown in the Yellow table.
- 4. This is an HER/Green bicolor light bar. HER electrical/optical characteristics are shown in the HER table. Green electrical/optical characteristics are shown in the Green table.
- 5. Does not apply to HLMP-2950 or HLMP-2965.

AlGaAs Red

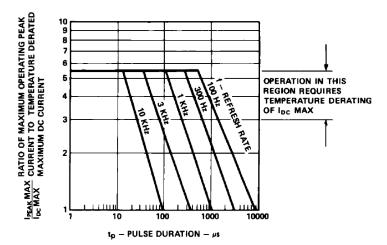


Figure 1. Maximum Allowable Peak Current vs. Pulse Duration.

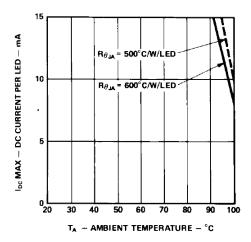


Figure 2. Maximum Allowed DC Current per LED vs. Ambient Temperature, T,MAX = 110 $^{\circ}\text{C}$.

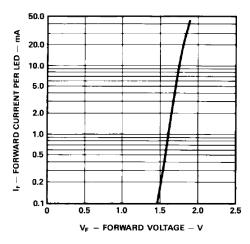


Figure 4. Forward Current vs. Forward Voltage.

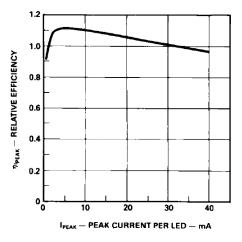


Figure 3. Relative Efficiency (Luminous Intensity per Unit Current) vs. Peak LED Current.

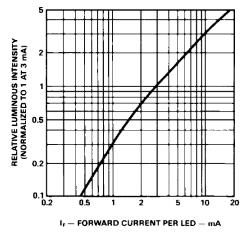


Figure 5. Relative Luminous Intensity vs. DC Forward Current.

HER, Yellow, Green

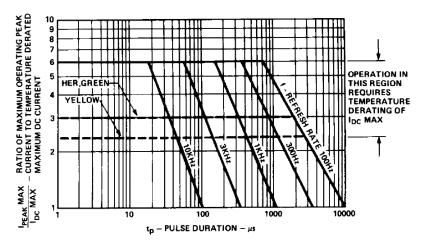


Figure 6. Maximum Allowed Peak Current vs. Pulse Duration.

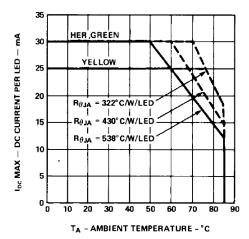


Figure 7. Maximum Allowable DC Current per LED vs. Ambient Temperature, $T_1MAX = 100^{\circ}C$.

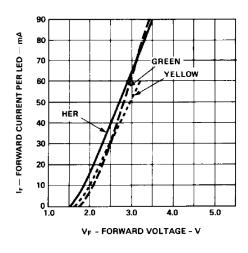


Figure 9. Forward Current vs. Forward Voltage Characteristics.

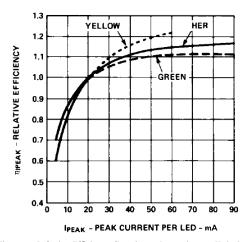


Figure 8. Relative Efficiency (Luminous Intensity per Unit Current) vs. Peak LED Current.

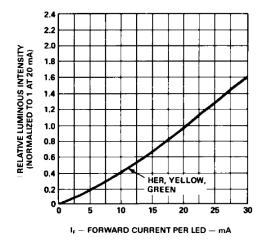


Figure 10. Relative Luminous Intensity vs. DC Forward Current.

For a detailed explanation on the use of data sheet information and recommended soldering procedures, see Application Notes 1005, 1027, and 1031.

Intensity Bin Limits (mcd)

HLMP-2300/2600/2620 Annunciators (.2 x .4 HER/AlGaAs), HLCP-A100/D100/E100

IV Bin Category	Min.	Max.
A	3.00	5.60
В	4.50	8.20
С	6.80	12.10
D	10.10	18.50
E	15.30	27.80
F	22.80	45.50
G	36.90	73.80

Notes:

- 1. Minimum category A for Red L/C AlGaAs (-A100/-D100/-E100).
- 2. Minimum category C for HER (-2300/-2600/-2620).

HLMP-2350/2635/2655/2670 Annunciators (.2 x .8 HER/Al-GaAs), HLCP-B100/C100/F100/G100 (.4 x .4 HER/AlGaAs)

IV Bin Category	Min.	Max.
A	5.40	10.90
В	9.00	16.00
С	13.10	24.00
D	19.70	36.10
E	29.60	54.20
F	44.90	88.80
G	71.90	143.80

Notes

- 1. Minimum category A for Red L/C AlGaAs (-B100/-C100/-F100/-G100).
- 2. Minimum category C for HER (-2350/-2635/-2670).

HLMP-2685/HLCP-H100 Annunciators (.4 x .8 HER/AIGaAs)

IV Bin Category	Min.	Max.	
A	10.80	22.00	
В	18.00	27.10	
С	22.00	40.80	
D	33.30	61.10	
E	50.00	91.80	
F	75.10	150.00	
G	121.70	243.40	

Notes:

- 1. Minimum category A for Red L/C AlGaAs (-H100).
- 2. Minimum category C for HER (-2685).

HLMP-2400/2700/2720 Annunciators (.2 x .4 Yellow)

IV Bin Category	Min.	Max.
С	6.10	11.20
D	9.20	16.80
Е	13.80	25.30
F	20.70	41.40
G	33.60	67.20

HLMP-2450/2735/2755/2770 Annunciators (.2 x .8 Yellow & .4 x .4 Yellow)

IV Bin Category	Min.	Max.	
С	13.00	22.00	
D	18.00	33.00	
Е	27.00	50.00	
F	40.50	81.00	
G	65.60	131.20	

HLMP-2785 Annunciators (.4 x .8 Yellow)

IV Bin Category	Min.	Max.
С	26.00	44.40
D	36.00	66.00
E	54.00	99.00
F	81.00	162.00
G	131.40	262.80

HLMP-2500/2800/2820 Annunciators (.2 x .4 Yellow)

IV Bin Category	Min.	Max.	
С	5.60	10.20	
D	8.40	15.30	
E	12.60	23.10	
F	18.90	37.80	
G	30.60	61.20	
Н	49.50	97.90	
I	80.10	158.40	

HLMP-2550/2835/2855/2870 Annunciators (.2 x .8/.4 x .4 Green)

IV Bin Category	Min.	Max.
С	11.30	20.60
D	17.00	31.00
Е	25.40	46.50
F	38.10	76.20
G	61.60	123.20
Н	99.81	197.67
I	161.73	320.21

HLMP-2885 Annunciators (.4 x .8 Green)

IV Bin Category	Min.	Max.
С	22.20	40.80
D	33.40	61.20
E	50.10	91.90
F	75.10	150.30
G	121.10	242.20
Н	196.10	383.50
I	313.70	613.60

HLMP-2950 Bi-Color Annunciators (.4 x .4 HER/Yellow)

Red Iv Categories		
IV Bin Category	Min.	Max.
С	11.30	20.60
D	17.00	31.00
Е	25.40	46.50
F	38.10	76.20
G	61.60	123.20
Yellow Iv Categories		
IV Bin Category	Min.	Max.
С	13.00	22.00
D	18.00	33.00
E	27.00	50.00
F	40.50	81.00

HLMP-2965 Bi-Color Annunciators (.4 x .4/.2 x .8 HER/Green)

131.20

65.60

Red Iv Categories		
IV Bin Category	Min.	Max.
D	19.70	36.10
Е	29.60	54.20
F	44.90	88.80
G	71.90	143.80
Green lv Categories		
IV Bin Category	Min.	Max.
В	7.50	13.90
C	11.30	20.60
D	17.00	31.00
Е	25.40	46.50
F	38.10	76.20
G	61.60	123.20
Н	100.00	200.00

Notes

G

- 1. Minimum category D for LPE Green (-2965).
- 2. In green mode, the devices are to be color binned into standard color bins, per Table 2. (-2685).

Color Categories

Dominant Wavelength (nm)

Color	Bin	Min.	Max.
Yellow	0	579.0	582.5
	1	581.5	585.0
	3	584.0	587.5
	2	586.5	590.0
	4	589.0	592.5
	5	591.5	595.0
Green	2	573.00	577.00
	3	570.00	574.00
	4	567.00	571.00
	5	564.00	568.00

Notes:

All categories are established for classification of products. Products may not be available in all categories. Please contact your local Avago representatives for further clarification/information.

Electrical

These light bars are composed of two, four, or eight light emitting diodes, with the light from each LED optically scattered to form an evenly illuminated light emitting surface.

The anode and cathode of each LED is brought out by separate pins. This universal pinout arrangement allows the LEDs to be connected in three possible configurations: parallel, series, or series parallel. The typical forward voltage values can be scaled from Figures 4 and 9. These values should be used to calculate the current limiting resistor value and typical power consumption. Expected maximum $V_{\rm F}$ values for driver circuit design and maximum power dissipation, may be calculated using the following $V_{\rm F}MAX$ models:

AlGaAs Red HLCP-X100 series

 $V_{E}MAX = 1.8 V + I_{Peak} (20 \Omega)$

For: $I_{p_{eak}} \le 20 \text{ mA}$

 $V_{E}MAX = 2.0 V + I_{Peak} (10 \Omega)$

For: 20 mA $\leq I_{p_{\text{pask}}} \leq 45 \text{ mA}$

HER (HLMP-2300/2600/2900), Yellow (HLMP-2400/2700/2900) and Green (HLMP-2500/2800/2900) series

 $V_{E}MAX = 1.6 + I_{Peak} (50 \Omega)$

For: $5 \text{ mA} \leq I_{\text{Peak}} \leq 20 \text{ mA}$

 $V_{E}MAX = 1.8 + I_{Peak} (40 \Omega)$

For: $I_{posk} \ge 20 \text{ mA}$

The maximum power dissipation can be calculated for any pulsed or DC drive condition. For DC operation, the maximum power dissipation is the product of the maximum forward voltage and the maximum forward current. For pulsed operation, the maximum power dissipation is the product of the maximum forward voltage at the peak forward current times the maximum average forward current. Maximum allowable power dissipation for any given ambient temperature and thermal resistance ($R\theta_{LA}$) can be determined by using Figure 2 or 7. The solid line in Figure 2 or 7 (R θ_{LA} of 600/538 C/W) represents a typical thermal resistance of a device socketed in a printed circuit board. The dashed lines represent achievable thermal resistances that can be obtained through improved thermal design. Once the maximum allowable power dissipation is determined, the maximum pulsed or DC forward current can be calculated.

Optical

Size of Light	Surface Area	
Emitting Area	Sq. Metres	Sq. Feet
8.89 mm x 8.89 mm	67.74 x 10 ⁻⁶	729.16 x 10 ⁻⁶
8.89 mm x 3.81 mm	33.87 x 10 ⁻⁶	364.58 x 10 ⁻⁶
8.89 mm x 19.05 mm	135.48 x 10 ⁻⁶	1458.32 x 10 ⁻⁶
3.81 mm x 19.05 mm	72.85 x 10 ⁻⁶	781.25 x 10 ⁻⁶

The radiation pattern for these light bar devices is approximately Lambertian. The luminous sterance may be calculated using one of the two following formulas:

$$L_{v}(cd/m^{2}) = \frac{I_{v}(cd)}{A(m^{2})}$$

$$L_v$$
 (footlamberts) = $\frac{\pi I_v$ (cd)}{A (ft²)

Refresh rates of 1 kHz or faster provide the most efficient operation resulting in the maximum possible time average luminous intensity.

The time average luminous intensity may be calculated using the relative efficiency characteristic of Figure 3 or 8, $\eta I_{PEAK'}$ and adjusted for operating ambient temperature. The time average luminous intensity at $T_A = 25$ °C is calculated as follows:

$$I_{v \text{TIMEAVG}} = \begin{bmatrix} I_{AVG} \\ I_{TSCT} \end{bmatrix}$$
 $(\eta I_{PEAK}) (I_{v} \text{ Data Sheet})$

where:

$$I_{TEST} = 3 \text{ mA}$$

for AlGaAs Red (HLMP-X000 series) 20 mA for HER, Yellow and Green (HLMP-2XXX series)

Example:

For HLMP-2735 series

$$\eta I_{PEAK} = 1.18$$
 at $I_{PEAK} = 48$ mA

$$I_{v \text{TIME AVG}} = \frac{12 \text{ mA}}{20 \text{ mA}}$$
 (1.18) (35 mcd)

= 25 mcd

The time average luminous intensity may be adjusted for operating ambient temperature by the following exponential equation:

$$I_{V}(T_{\Delta}) = I_{V}(25^{\circ}C)e^{[K(T - 25^{\circ}C)]}$$

Color	K
AlGaAs Red	-0.0095/°C
HER	-0.0131/°C
Yellow	−0.0112/°C
Green	-0.0104/°C

Example:

$$I_v$$
 (80°C) = (25 mcd) $e^{[-0.0112 (80-25)]}$
= 14 mcd.

Mechanical

These light bar devices may be operated in ambient temperatures above $+60^{\circ}\text{C}$ without derating when installed in a PC board configuration that provides a thermal resistance pin to ambient value less than $280^{\circ}\text{C/W/LED}$. See Figure 2 or 7 to determine the maximum allowed thermal resistance for the PC board, $R\theta_{\text{PC-A}}$, which will permit nonderated operation in a given ambient temperature.

To optimize device optical performance, specially developed plastics are used which restrict the solvents that may be used for cleaning. It is recommended that only mixtures of Freon (F113) and alcohol be used for vapor cleaning processes, with an immersion time in the vapors of less than two (2) minutes maximum. Some suggested vapor cleaning solvents are Freon TE, Genesolv DES, Arklone A or K. A 60°C (140°F) water cleaning process may also be used, which includes a neutralizer rinse (3% ammonia solution or equivalent), a surfactant rinse (1% detergent solution or equivalent), a hot water rinse and a thorough air dry. Room temperature cleaning may be accomplished with Freon T-E35 or T-P35, Ethanol, Isopropanol or water with a mild detergent.

For further information on soldering LEDs please refer to Application Note 1027.

For product information and a complete list of distributors, please go to our web site:

www.avagotech.com

